



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Koji Nakayama

Serial No. : 10/542,718

Filed : July 20, 2005

For : EPOXY GROUP-CONTAINING SILICON COMPOUND
AND THERMOSETTING RESIN COMPOSITION

Examiner : Zimmer, Marc S.

Art Unit : 1712

Confirmation
No. : 1882

Customer No. : 42754

Attorney
Docket No. : 442P098

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

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Kevin S. Lemack
Name of applicant, assignee, or Registered
Representative
[Signature]
Signature
August 2, 2007
Date

Sir:

AMENDMENT

In response to the Office Action dated May 16, 2007,
please amend the above-identified application as follows:

Remarks begin on page 2 of this paper.

Amendments to the claims begin on page 7 of this paper.